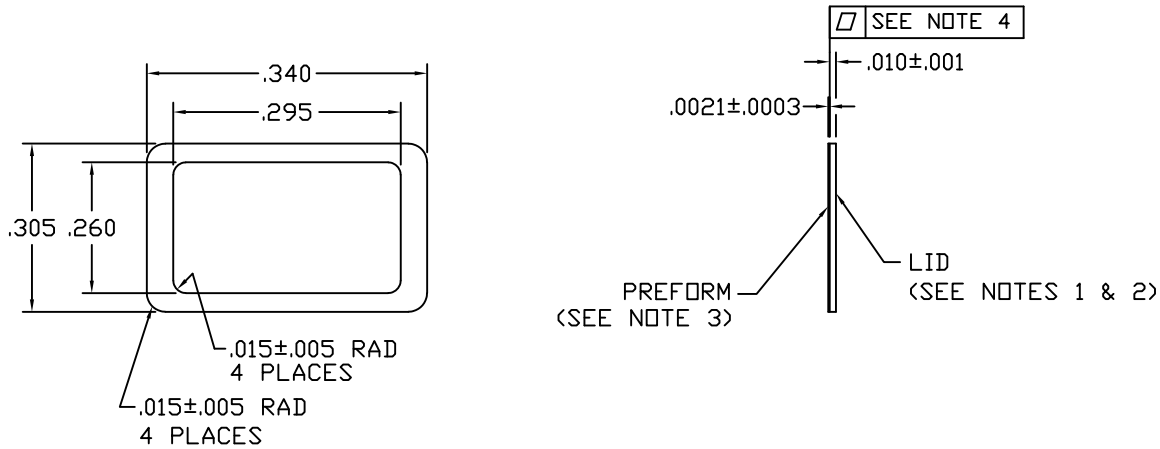


# SSM P/N CL343003



**NOTES**

1. MAT'L : KOVAR OR ALLOY 42
2. PLATING : 1st LAYER 50/350 MICROINCHES NI  
 2nd LAYER 25 MICROINCHES MIN Au  
 3rd LAYER 50/350 MICROINCHES NI  
 4th LAYER 25 MICROINCHES MIN Au

NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.

3. PREFORM - 80% ±1% Au  
 20% Sn
4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
5. TOLERANCES TO BE (XXX) 3 PLACES ±.003 UNLESS OTHERWISE NOTED

DESIGN	BW	08/03 89	DESCRIPTION Hi-Rel Combo Lid	
APPRD	VG	03/08 00	PART NAME CL343003	SCALE 4 = 1
			DEPT	
Spectrum Semiconductor Materials, Inc. 155 Nicholson Lane San Jose, CA 95134 PH: (408) 435-5555 Fx: (408)435-8226			MFG: Williams Advanced Materials, Inc. PART No. W883H	

